1432 & Soldering

Solder — continued

Crystal Cored 60/40 Alloy



- Halide free version Crystal 400
- Halide activated Crystal 511 (1.1% Halide)
- Fast soldering
- Good spread on copper brass and nick-
- Clear residues
- Heat stable low fuming and low spittina
- Mild odour
- Melting temperature 188°C (bit temperature approximately 340°C)

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Crystal 400 (Ha	lide free)		Price Pe	er Reel	
250g Reels	Order Code	1+	5+	10+	20+
0.91mm	609-950				
0.71mm	609-961				
500g Reels					
0.91mm	609-973				
0.71mm	609-985				
Crystal 505					
500g Reels					
0.91mm	329-4158				
0.71mm	329-4160				
Crystal 511 (con	tains Halide)				
250g Reels					
0.91mm	609-997				
0.71mm	610-008				
500g Reels					
0.91mm	610-010				
0.71mm	610-021				

Smart Wire



- Silver loaded solder
- 62/36/2 tin/lead/silver
- Good resistance to thermal fatigue
- Minimises silver leaching from plated terminations
- Non-corrosive residue
- Designed to optimise hand soldering of surface mount components
- Melting temperature 179°C
- Bit temperature approximately 320°C

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250g Reel, 26swg/0.46mm Price Per Reel							
Mftrs. List No. Order Co	de 1+	5+	10+	20+	40+	100+	
SMART26 419-503	3.						

No Clean, Low Fuming X38, X39 Flux



- Low flux content (1%)
- Specially formulated to compliment 'no clean" wave and reflow soldering processes
- Halide free
- Low fuming and low spitting
- Limited flux residues meet reliability requirements of Bellcore and IPC Class 3 specifications
- Melting temperature 188°C
- Bit temperature approx. 308°C Suitable for repair work following a cleaning process to eliminate the need for further cleaning

X39 Flux

- Aggressive
- Acts marginally better on copper than X38
 Wets brass very effectively
- X38 Flux
- Leaves clear residues
- Leaves turbid residue
- Good post production inspection

1	اما					Price P	or Rool		
		ngth (m)	Order Code	1+	5+	10+	20+	40+	100+
	X38, 250g F 1.22mm 0.71mm	Reels 30 89	289-796 289-802						
		Reels 61 178	289-814 289-826						
	X39, 250g F 1.22mm 0.71mm	Reels 30 89	289-838 289-840						
	X39, 500g F 1.22mm 0.71mm 1	Reels 61 178	289-851 289-863						

No Clean X52 flux



- X52 cored 60/40 tin/lead solder
- Nominal flux content (1%)
- Negligible residues eliminate cost of cleaning
- Non-corrosive
- Offers fast and sustained soldering on copper and brass
- Conforms to EN29453 and
- S-Sn60Pb40E
- Specially formulated to compliment no clean wave and reflow soldering processers where extra activity is required
- Also can be used to repair after a cleaning process to eliminate the need for further
- Recommended tip temperature 340-420°C

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	Order		-	rice Per Re	el	
mm	Code	1+	5+	10+	20+	40+
250g Reels						
1.22mm	904-533					
0.71mm	904-545					
500g Reels						
1.22mm	904-557					
0.71mm	904-569					

High and Low Melting Point



High Melting Point

- Suitable to solder products that will operate under
- high temperatures in working life
 Used for selective soldering of adjacent components
- during multi-stage board assembly Contains 5% tin, 93.5% lead, 1.5% silver
- Melting temperature 301°C
- Recommended junction temperature 356°C
- Bit temperature approximately 421°C

Low Melting Point

- Slightly lower melting point than standard 60/40 solder
- Superior wetting and electrical conductivity
- Contains 62% tin, 36% lead, 2% silver
- 2% silver content prevents leaching and the formation of brittle joints during soldering of silver and gold plated surfaces
- Melting temperature 179°C

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mm		n Mftrs. List No.	Order Code	1+	5+	 er Reel 20+	40+	100+
	. ,	ire 179°C	0000	••	٠.	 		
250g Ree	els							
0.71mm 0.56mm	93 150	DLMP222 DLMP242 DLMP262	.419-552					
500g Ree	els							
1.22m	63	DLMP DLMP225	.419-576 .419-588					
High Ten	nperat	ure 301°C						
500g Ree 1.22mm		DHMP	.419-590					